505664506 09/10/2019

PATENT ASSIGNMENT COVER SHEET

Electronic Version v1.1 Stylesheet Version v1.2 EPAS ID: PAT5711312

SUBMISSION TYPE:	NEW ASSIGNMENT
NATURE OF CONVEYANCE:	ASSIGNMENT

CONVEYING PARTY DATA

Name	Execution Date
KATSUMI HONDA	07/25/2019

RECEIVING PARTY DATA

Name:	SONY SEMICONDUCTOR SOLUTIONS CORPORATION
Street Address:	4-14-1 ASAHI-CHO
Internal Address:	ATSUGI-SHI
City:	KANAGAWA
State/Country:	JAPAN
Postal Code:	2430014

PROPERTY NUMBERS Total: 1

Property Type	Number
Application Number:	16476747

CORRESPONDENCE DATA

Fax Number: (312)803-4960

Correspondence will be sent to the e-mail address first; if that is unsuccessful, it will be sent

using a fax number, if provided; if that is unsuccessful, it will be sent via US Mail.

Email: docketing@chiplawgroup.com

CHIP LAW GROUP Correspondent Name: Address Line 1: 155 N WACKER DR

Address Line 2: **SUITE 4250**

Address Line 4: CHICAGO, ILLINOIS 60606

ATTORNEY DOCKET NUMBER:	SP368164US00
NAME OF SUBMITTER:	PRAMOD CHINTALAPOODI
SIGNATURE:	/Pramod Chintalapoodi/
DATE SIGNED:	09/10/2019

Total Attachments: 1

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PATENT REEL: 050334 FRAME: 0622 505664506

Attorney Docket No.: Sony Ref. No.: SP368164US00

DECLARATION (37 CFR 1.63) FOR UTILITY OR DESIGN APPLICATION USING AN APPLICATION DATA SHEET (37 CFR 1.76) AND ASSIGNMENT FOR SINGLE ASSIGNEE

Title of Invention	IMAGING ELEMENT, IMAGING ELEMENT CONTROL METHOD, IMAGING APPARATUS, AND ELECTRONIC DEVICE
As the below	named inventor, I hereby declare that:
This declarati	1 The infalling minimum of early
The above-id	United States application or PCT international application number PCT/JP2018/000096 filed on 2018/01/05 emified application was made or authorized to be made by me.
I believe that WHEREAS,	I am the original inventor or an original joint inventor of a claimed invention in the application. SONY SEMICONDUCTOR SOLUTIONS CORPORATION , with offices at
1 1 1 1 1 1 1 1	
acquiring all	sahi-cho, Atsugi-shi, Kanagawa, Japan (hereinafter referred to as ASSIGNEE), is desirous of interest in, to and under said invention, said application disclosing the invention and in, to and under any Letters Patent or similar on which may be granted therefor in the United States and in any and all foreign countries;
of which are legal represer in and to any any and all pr Convention I adheres, and United States	EFORE, in consideration of the sum of One Dollar (\$1.00), and other good and valuable consideration, the receipt and sufficiency hereby acknowledged, I by these presents do hereby assign, sell and transfer unto said ASSIGNEE, its successors, assigns, and natatives, the entire right, title and interest in said invention, said application, including any divisions and continuations thereof, and and all Letters Patent of the United States, and countries foreign thereto, which may be granted for said invention, and in and to riority rights and/or convention rights under the International Convention for the Protection of Industrial Property, Inter-American Relating to Patents, Designs and Industrial Models, and any other international agreements to which the United States of America to any other benefits accruing or to accrue to me with respect to the filting of applications for patents or securing of patents in the rand countries foreign thereto, and I hereby authorize and request the Commissioner of Patents to issue said United States Letters I ASSIGNEE, as the assignee of the whole right, title and interest thereto;
designee, as remuneration	r agree to execute all necessary or desirable and lawful future documents, including assignments in favor of ASSIGNEE or its ASSIGNEE or its successors, assigns and legal representatives may from time-to-time present to me and without further it, in order to perfect title in said invention, modifications, and improvements in said invention, applications and Letters Patent of ates and countries foreign thereto;
application fo	or agree to properly execute and deliver and without further remuneration, such necessary or desirable and lawful papers for or foreign patents, for filing subdivisions of said application for patent, and or, for obtaining any reissue or reissues of any Letters may be granted for my aforesaid invention, as said ASSIGNEE thereof shall bereafter require and prepare at its own expense;
application, s	er agree that ASSIGNEE will, upon its request, be provided promptly with all pertinent facts and documents relating to said said invention and said Letters Patent and legal equivalents in foreign countries as may be known and accessible to me and will be same in any interference or litigation related thereto;
And I hereby this assignme	covenant that no assignment, sale, agreement or encumbrance has been or will be made or entered into which would conflict with ent and sale.
	nowledge that any willful false statement made in this declaration is punishable under 18 U.S.C. 1001 by fine or imprisonment of n five (5) years, or both.
LEGAL NA	ME OF INVENTOR
inventor:	KATSUMI HONDA Date: July 25, 20/9
Signature:	Hotouni Handa

PATENT REEL: 050334 FRAME: 0623

RECORDED: 09/10/2019